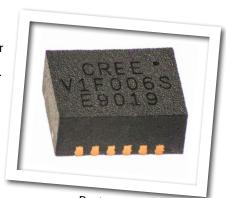


## CGHV1F006S

#### 6 W, DC - 15 GHz, 40V, GaN HEMT

Cree's CGHV1F006S is an unmatched, gallium nitride (GaN) high electron mobility transistor (HEMT) designed specifically for high efficiency, high gain and wide bandwidth capabilities. The device can be deployed for L, S, C, X and Ku-Band amplifier applications. The datasheet specifications are based on a C-Band (5.5 - 6.5 GHz) amplifier. Additional application circuits are available for C-Band at 5.8 GHz - 7.2 GHz and X-Band at 7.9 - 8.4 GHz and 8.5 - 9.6 GHz. The CGHV1F006S operates on a 40 volt rail circuit while housed in a 3mm x 4mm, surface mount, dual-flat-no-lead (DFN) package. Under reduced power, the transistor can operate below 40V to as low as 20V V<sub>DD</sub> maintaining high gain and efficiency.



Package Type: 3x4 DFN PN: CGHV1F006S

#### Typical Performance 5.5-6.5 GHz (T<sub>c</sub> = 25°C), 40 V

| Parameter                                   | 5.5 GHz | 6.0 GHz | 6.5 GHz | Units |
|---|---------|---------|---------|-------|
| Small Signal Gain                           | 15.4    | 16.5    | 17.8    | dB    |
| Output Power @ P <sub>IN</sub> = 28 dBm     | 38.6    | 39.3    | 39.0    | dBm   |
| Drain Efficiency @ P <sub>IN</sub> = 28 dBm | 55      | 57      | 52      | %     |

#### Note:

Measured in the CGHV1F006S-AMP application circuit. Pulsed 100 µs 10% duty.

#### Features for 40 V in CGHV1F006S-AMP

- Up to 15 GHz Operation
- 8 W Typical Output Power
- 17 dB Gain at 6.0 GHz
- 15 dB Gain at 9.0 GHz
- Application circuits for 5.8 7.2 GHz, 7.9 8.4 GHz, and 8.5 9.6 GHz.
- High degree of APD and DPD correction can be applied

Large Signal Models Available for ADS and MWO

#### Listing of Available Hardware Application Circuits / Demonstration Circuits

| Application Circuit | Operating Frequency | Amplifier Class | Operating Voltage |
|---------------------|---------------------|-----------------|-------------------|
| CGHV1F006S-AMP1     | 5.85 - 7.2 GHz      | Class A/B       | 40 V              |
| CGHV1F006S-AMP2     | 7.9 - 8.4 GHz       | Class A/B       | 40 V              |
| CGHV1F006S-AMP3     | 8.5 - 9.6 GHz       | Class A/B       | 40 V              |
| CGHV1F006S-AMP4     | 4.9 - 5.9 GHz       | Class A/B       | 20 V              |



#### Absolute Maximum Ratings (not simultaneous) at 25°C Case Temperature

| Parameter   | Symbol                             | Rating    | Units | Notes |
|---|------------------------------------|-----------|-------|-------|
| Drain-Source Voltage                              | $V_{\scriptscriptstyle DSS}$       | 100       | Volts | 25°C  |
| Gate-to-Source Voltage                            | $V_{\sf GS}$                       | -10, +2   | Volts | 25°C  |
| Storage Temperature                               | $T_{STG}$                          | -65, +150 | °C    |       |
| Operating Junction Temperature                    | $T_{\!\scriptscriptstyleJ}$        | 225       | °C    |       |
| Maximum Forward Gate Current                      | I <sub>GMAX</sub>                  | 1.2       | mA    | 25°C  |
| Maximum Drain Current <sup>1</sup>                | I <sub>DMAX</sub>                  | 0.95      | Α     | 25°C  |
| Soldering Temperature <sup>2</sup>                | $T_{s}$                            | 245       | °C    |       |
| Case Operating Temperature <sup>3,4</sup>         | T <sub>c</sub>                     | -40, +150 | °C    |       |
| Thermal Resistance, Junction to Case <sup>5</sup> | $R_{\scriptscriptstyle{\thetaJC}}$ | 14.5      | °C/W  | 85°C  |

#### Note:

## Electrical Characteristics (T<sub>c</sub> = 25°C) - 40 V Typical

| Characteristics  | Symbol                  | Min.        | Тур. | Max. | Units           | Conditions   |
|--|-------------------------|-------------|------|------|-----------------|--|
| DC Characteristics <sup>1</sup>  |                         |             |      |      |                 |  |
| Gate Threshold Voltage   | V <sub>GS(th)</sub>     | -3.6        | -3.0 | -2.4 | V <sub>DC</sub> | V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1.2 mA  |
| Gate Quiescent Voltage   | $V_{_{GS(\mathtt{Q})}}$ | -           | -2.7 | -    | V <sub>DC</sub> | V <sub>DS</sub> = 40 V, I <sub>D</sub> = 60 mA   |
| Saturated Drain Current <sup>2</sup>   | I <sub>DS</sub>         | -           | -1.0 | -    | А               | $V_{DS} = 6.0 \text{ V, } V_{GS} = 2.0 \text{ V}$  |
| Drain-Source Breakdown Voltage   | $V_{(BR)DSS}$           | 100         | -    | -    | V <sub>DC</sub> | $V_{GS} = -8 \text{ V, } I_{D} = 1.2 \text{ mA}$   |
| RF Characteristics <sup>3</sup> (T <sub>c</sub> = 25°C, F <sub>0</sub> = 5.925 GHz | unless otherv           | vise noted) |      |      |                 |  |
| Gain <sup>3,4</sup>  | G                       | -           | 16.6 | -    | dB              | V <sub>DD</sub> = 40 V, I <sub>DQ</sub> = 60 mA, P <sub>IN</sub> = 10 dBm                                    |
| Output Power <sup>3,4</sup>  | P <sub>out</sub>        | -           | 38.5 | -    | dBm             | V <sub>DD</sub> = 40 V, I <sub>DQ</sub> = 60 mA, P <sub>IN</sub> = 26 dBm                                    |
| Drain Efficiency <sup>3,4</sup>  | η                       | -           | 45   | -    | %               | V <sub>DD</sub> = 40 V, I <sub>DQ</sub> = 60 mA, P <sub>IN</sub> = 26 dBm                                    |
| Output Mismatch Stress <sup>4</sup>  | VSWR                    | -           | 10:1 | -    | Ψ               | No damage at all phase angles,<br>$V_{DD} = 40 \text{ V, } I_{DQ} = 60 \text{ mA, } P_{IN} = 26 \text{ dBm}$ |
| Dynamic Characteristics  |                         |             |      |      |                 |  |
| Input Capacitance <sup>5</sup>   | C <sub>gs</sub>         | -           | 1.3  | -    | pF              | $V_{DS}$ = 40 V, $V_{gs}$ = -8 V, f = 1 MHz  |
| Output Capacitance <sup>5</sup>  | C <sub>DS</sub>         | -           | 0.31 | -    | pF              | $V_{DS}$ = 40 V, $V_{gs}$ = -8 V, f = 1 MHz  |
| Feedback Capacitance   | $C_{GD}$                | -           | 0.04 | -    | pF              | $V_{DS} = 40 \text{ V, } V_{gs} = -8 \text{ V, } f = 1 \text{ MHz}$  |

#### Notes:

<sup>&</sup>lt;sup>1</sup> Current limit for long term, reliable operation

<sup>&</sup>lt;sup>2</sup> Refer to the Application Note on soldering at www.cree.com/rf/document-library

<sup>&</sup>lt;sup>3</sup> Simulated at P<sub>DISS</sub> = 2.4 W

 $<sup>{}^4</sup>T_c$  = Case temperature for the device. It refers to the temperature at the ground tab underneath the package. The PCB will add additional thermal resistance.

 $<sup>^5</sup>$ The R<sub>TH</sub> for Cree's application circuit, CGHV1F006S-AMP, with 31 (Ø11 mil) via holes designed on a 20 mil thick Rogers 5880 PCB, is  $3.9^{\circ}$ C/W. The total R<sub>TH</sub> from the heat sink to the junction is  $14.5^{\circ}$ C/W +  $3.9^{\circ}$ C/W =  $18.4^{\circ}$ C/W.

<sup>&</sup>lt;sup>1</sup> Measured on wafer prior to packaging

<sup>&</sup>lt;sup>2</sup> Scaled from PCM data

 $<sup>^{\</sup>rm 3}$  Measured in Cree's production test fixture. This fixture is designed for high volume testing at 5.925 GHz

<sup>&</sup>lt;sup>4</sup> Unmodulated Pulsed Signal 100 μs, 10% duty cycle

<sup>5</sup> Includes package



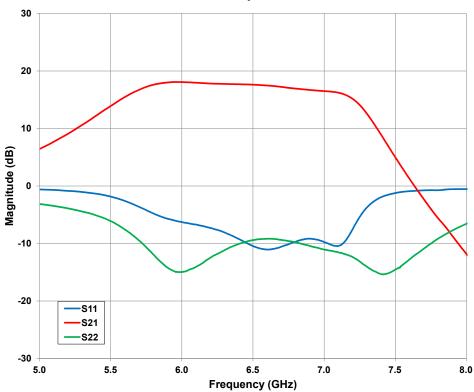
#### Electrical Characteristics When Tested in CGHV1F006S-AMP1 at C-Band Under OQPSK

| Characteristics  | Symbol           | Min. | Тур. | Max. | Units | Conditions  |  |
|--|------------------|------|------|------|-------|---|--|
| RF Characteristics¹ (T <sub>c</sub> = 25°C, F <sub>0</sub> = 5.8 - 7.2 GHz unless otherwise noted) |                  |      |      |      |       |   |  |
| Gain   | G                | -    | 17.5 | -    | dB    | V <sub>DD</sub> = 40 V, I <sub>DQ</sub> = 60 mA, P <sub>IN</sub> = 0 dBm    |  |
| Output Power <sup>2</sup>  | P <sub>out</sub> | -    | 39   | -    | dBm   | $V_{DD} = 40 \text{ V, } I_{DQ} = 60 \text{ mA, } P_{IN} = 27 \text{ dBm}$  |  |
| Drain Efficiency <sup>2</sup>  | η                | -    | 55   | -    | %     | $V_{DD} = 40 \text{ V, } I_{DQ} = 60 \text{ mA, } P_{IN} = 27 \text{ dBm}$  |  |
| OQPSK <sup>3</sup>   | ACLR             | -    | -36  | -    | dBc   | $V_{DD} = 40 \text{ V, } I_{DQ} = 60 \text{ mA, } P_{OUT} = 33 \text{ dBm}$ |  |
| Output Mismatch Stress <sup>2</sup>  | VSWR             | -    | 10:1 | -    | Ψ     | No damage at all phase angles, $V_{\rm DS}$ = 40 V, $I_{\rm DQ}$ = 60 mA    |  |

#### Notes:

#### Typical Performance - CGHV1F006S-AMP1 at C-Band Under OQPSK

Figure 1. - Typical Small Signal Response of CGHV1F006S-AMP1 Application Circuit  $V_{\text{DD}}$  = 40 V,  $I_{\text{DO}}$  = 60 mA



<sup>&</sup>lt;sup>1</sup> Measured in CGHV1F006S-AMP1 Application Circuit

<sup>&</sup>lt;sup>2</sup> Pulsed 100 µs, 10% duty cycle

<sup>&</sup>lt;sup>3</sup> OQPSK modulated signal, 1.6 msps, PN23, Alpha Filter = 0.2 Offset = 1.6 MHz



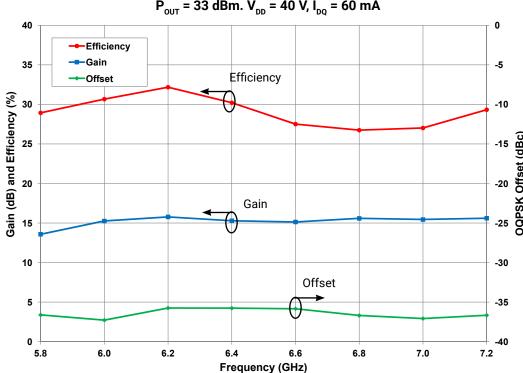


Figure 2. - Typical Gain, Efficiency and OQPSK Performance vs Frequency  $P_{out}$  = 33 dBm.  $V_{dD}$  = 40 V,  $I_{dQ}$  = 60 mA

Figure 3. - Typical Gain, Efficiency and OQPSK Performance vs Input Power OQPSK Transfer Frequency = 7.2 GHz,  $V_{DD} = 40 \text{ V}$ ,  $I_{DO} = 60 \text{ mA}$ 

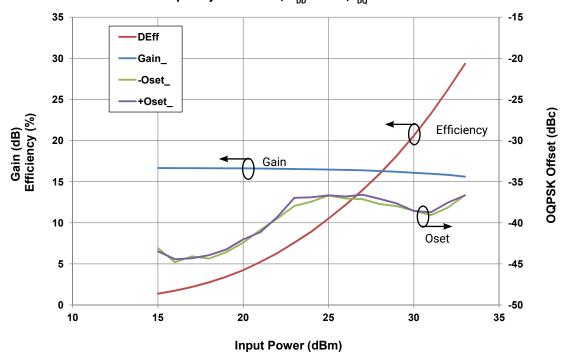
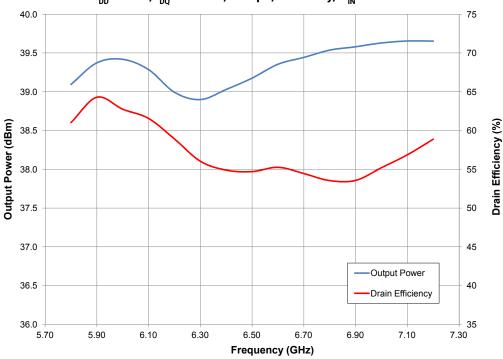




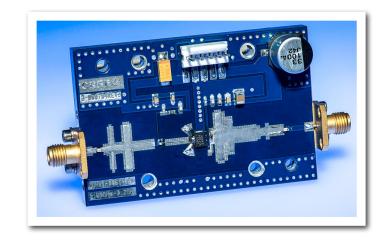
Figure 4. - Typical Pulsed Power Response  $V_{DD}$  = 40 V,  $I_{DO}$  = 60 mA, 100  $\mu$ s, 10% Duty,  $P_{IN}$  = 27 dBm



## CGHV1F006S-AMP1 Application Circuit Bill of Materials, OQPSK

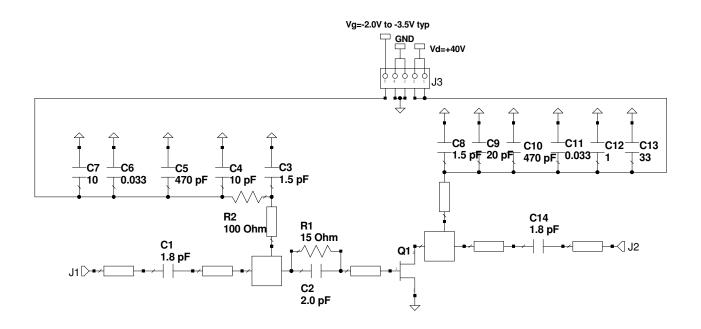
## **CGHV1F006S-AMP1 Application Circuit**

| Designator | Description                         | Qty |
|------------|-------------------------------------|-----|
| R1         | RES, 15, OHM, +1/-1%, 1/16 W, 0402  | 1   |
| R2         | RES, 100, OHM, +1/-1%, 1/16 W, 0603 | 1   |
| C1, C14    | CAP, 1.8 pF, ±0.1 pF, 0603, ATC     | 2   |
| C2         | CAP, 2.0 pF, ±0.1 pF, 0402, ATC     | 1   |
| C3, C8     | CAP, 1.5 pF, ±0.1 pF, 0402, ATC     | 2   |
| C4         | CAP, 10 pF, ±5%, 0603, ATC          | 1   |
| C5, C10    | CAP, 470 pF, 5%, 100 V, 0603, X     | 2   |
| C6, C11    | CAP, 33000 pF, 0805, 100V, X7R      | 2   |
| C7         | CAP, 10 UF, 16 V, TANTALUM          | 1   |
| C9         | CAP, 20 pF, ±5%, 0603, ATC          | 1   |
| C12        | CAP, 1.0 UF, 100V, 10% X7R, 1210    | 1   |
| C13        | CAP, 33 UF, 20%, G CASE             | 1   |
| J1, J2     | CONN, SMA, PANEL MOUNT JACK, FLANGE | 2   |
|            | PCB, RT5880, 0.020" THK, CGHV1F006S | 1   |
| J3         | HEADER RT>PLZ .1CEN LK 5POS         | 1   |
| Q1         | QFN TRANSISTOR CGHV1F006S           | 1   |

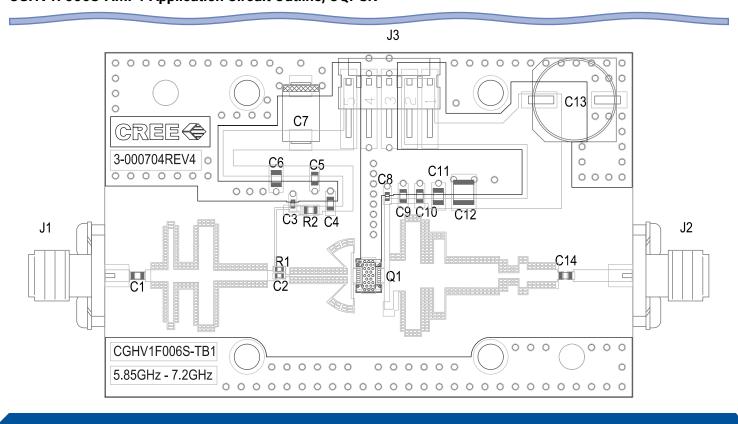




#### CGHV1F006S-AMP1 Application Circuit Schematic, OQPSK



### CGHV1F006S-AMP1 Application Circuit Outline, OQPSK





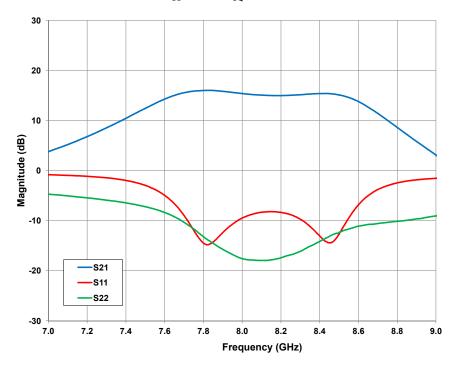
#### Electrical Characteristics When Tested in CGHV1F006S-AMP2 at X-Band, SATCOM

| Characteristics  | Symbol           | Min. | Тур. | Max. | Units | Conditions  |  |
|--|------------------|------|------|------|-------|---|--|
| RF Characteristics¹ (T <sub>c</sub> = 25°C, F <sub>0</sub> = 7.9 - 8.4 GHz unless otherwise noted) |                  |      |      |      |       |   |  |
| Gain   | G                | -    | 15   | -    | dB    | $V_{\rm DD}$ = 40 V, $I_{\rm DQ}$ = 60 mA, $P_{\rm IN}$ = 0 dBm                                 |  |
| Output Power <sup>2</sup>  | P <sub>out</sub> | -    | 39   | -    | dBm   | $V_{DD} = 40 \text{ V, } I_{DQ} = 60 \text{ mA, } P_{IN} = 28 \text{ dBm}$                      |  |
| Drain Efficiency <sup>2</sup>  | η                | -    | 55   | -    | %     | $V_{\rm DD}$ = 40 V, $I_{\rm DQ}$ = 60 mA, $P_{\rm IN}$ = 28 dBm                                |  |
| OQPSK <sup>3</sup>   | ACLR             | -    | -37  | -    | dBc   | V <sub>DD</sub> = 40 V, I <sub>DQ</sub> = 60 mA, P <sub>OUT</sub> = 33 dBm                      |  |
| Output Mismatch Stress <sup>2</sup>  | VSWR             | -    | 10:1 | -    | Υ     | No damage at all phase angles, $V_{\rm DD}$ = 40 V, $I_{\rm DQ}$ = 60 mA, $P_{\rm IN}$ = 28 dBm |  |

#### Notes:

#### Typical Performance in Application Circuit CGHV1F006S-AMP2 at X-Band, SATCOM

Figure 5. - Typical Small Signal Response of CGHV1F006S-AMP2 Application Circuit  $V_{DD}$  = 40 V,  $I_{DO}$  = 60 mA

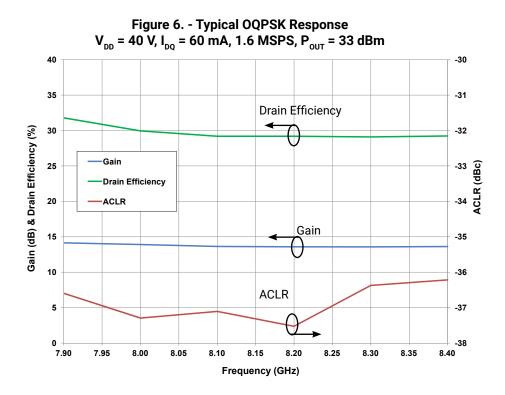


<sup>&</sup>lt;sup>1</sup> Measured in CGHV1F006S-AMP2 Application Circuit

<sup>&</sup>lt;sup>2</sup> Pulsed 100 µs, 10% duty cycle

<sup>&</sup>lt;sup>3</sup> OQPSK modulated signal, 1.6 msps, PN23, Alpha Filter = 0.2 Offset = 1.6 MHz





#### Typical Performance in Application Circuit CGHV1F006S-AMP2

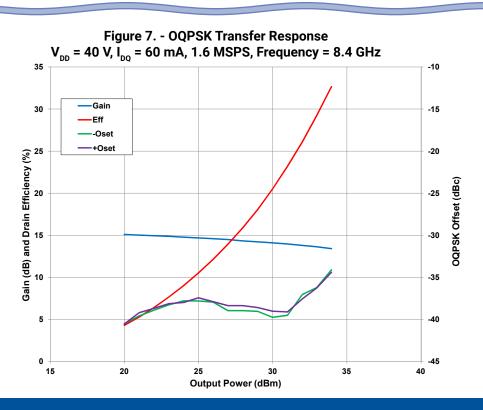




Figure 8. - Typical Pulsed Power Response

V<sub>DD</sub> = 40 V, I<sub>DQ</sub> = 60 mA, 100 μs, 10% Duty, P<sub>IN</sub> = 28 dBm

Output Power

39.5

Drain Efficiency

55

μεία

37.0

36.5

## CGHV1F006S-AMP2 Application Circuit Bill of Materials, SATCOM

36.0 <del>-</del> 7.80

7.90

8.00

8.10

Frequency (GHz)

8.20

8.30

| Designator | Description                         | Qty |
|------------|-------------------------------------|-----|
| R1         | RES, 15, OHM, +1/-1%, 1/16 W, 0402  | 1   |
| R2         | RES, 100, OHM, +1/-1%, 1/16 W, 0603 | 1   |
| C3, C8     | CAP, 1.0pF, ±0.05 pF, 0402, ATC     | 2   |
| C14        | CAP, 1.0pF, ±5%, 0603, ATC          | 1   |
| C1         | CAP, 1.2pF, ±5%, 0603, ATC          | 1   |
| C2         | CAP, 1.6pF, ±5%, 0402, ATC          | 1   |
| C4         | CAP, 10pF, ±5%, 0603, ATC           | 1   |
| C5, C10    | CAP, 470pF, 5%, 100V, 0603, X       | 2   |
| C6,C11     | CAP, 33000pF, 0805, 100V, X7R       | 2   |
| C7         | CAP, 10 UF, 16 V, TANTALUM          | 1   |
| C9         | CAP, 20 pF, ±5%, 0603, ATC          | 1   |
| C12        | CAP, 1.0 UF, 100V, 10% X7R, 1210    | 1   |
| C13        | CAP, 33 UF, 20%, G CASE             | 1   |
| J1, J2     | CONN, SMA, PANEL MOUNT JACK, FLANGE | 2   |
|            | PCB, RT5880, 0.020" THK, CGHV1F006S | 1   |
|            | BASEPLATE, AL, 2.60 X 1.70 X 2.50   | 1   |
| J3         | HEADER RT>PLZ .1CEN LK 5POS         | 1   |
|            | 2-56 SOC HD SCREW 1/4 SS            | 4   |
|            | #2 SPLIT LOCKWASHER SS              | 4   |
| Q1         | QFN TRANSISTOR CGHV1F006S           | 1   |

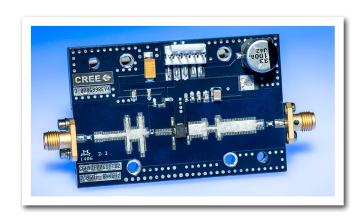
#### **CGHV1F006S-AMP2 Application Circuit**

35

8.50

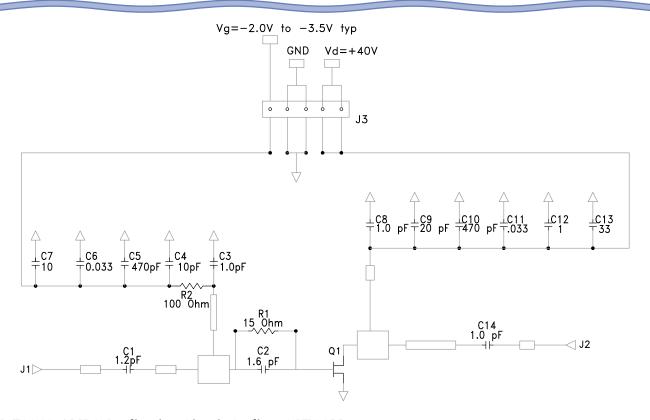
Efficiency

8.40

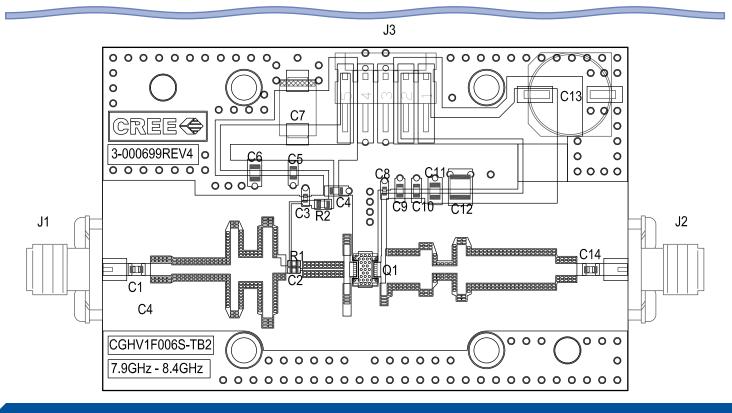




#### CGHV1F006S-AMP2 Application Circuit Schematic, SATCOM



### CGHV1F006S-AMP2 Application Circuit Outline, SATCOM



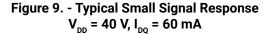


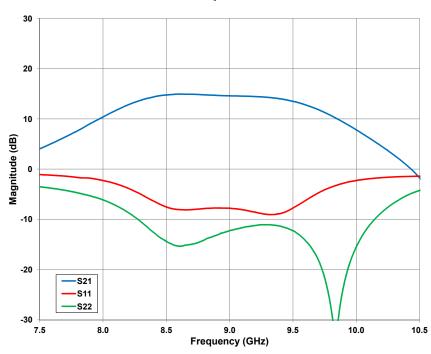
## Electrical Characteristics When Tested in CGHV1F006S-AMP3 at X-Band, RADAR

| Characteristics  | Symbol           | Min. | Тур. | Max. | Units | Conditions   |  |
|--|------------------|------|------|------|-------|--|--|
| RF Characteristics¹ (T <sub>c</sub> = 25°C, F <sub>0</sub> = 8.5 - 9.6 GHz unless otherwise noted) |                  |      |      |      |       |  |  |
| Gain   | G                | -    | 14.5 | -    | dB    | V <sub>DD</sub> = 40 V, I <sub>DQ</sub> = 60 mA, P <sub>IN</sub> = 0 dBm   |  |
| Output Power <sup>2</sup>  | P <sub>out</sub> | -    | 38.5 | -    | dBm   | $V_{DD} = 40 \text{ V, } I_{DQ} = 60 \text{ mA, } P_{IN} = 28 \text{ dBm}$ |  |
| Drain Efficiency <sup>2</sup>  | η                | -    | 52   | -    | %     | $V_{DD} = 40 \text{ V, } I_{DQ} = 60 \text{ mA, } P_{IN} = 28 \text{ dBm}$ |  |
| Output Mismatch Stress <sup>2</sup>  | VSWR             | -    | 10:1 | -    | Υ     | $V_{DD} = 40 \text{ V, } I_{DQ} = 60 \text{ mA, } P_{IN} = 28 \text{ dBm}$ |  |

#### Notes:

## Typical Performance in Application Circuit CGHV1F006S-AMP3 at X-Band, RADAR



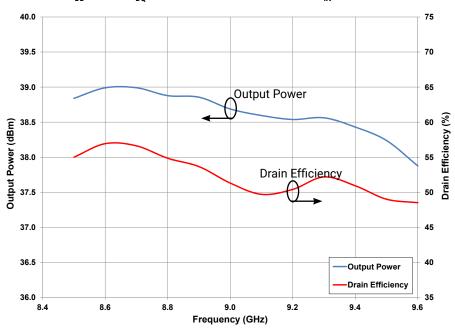


<sup>&</sup>lt;sup>1</sup> Measured in CGHV1F006S-AMP3 Application Circuit

 $<sup>^2</sup>$  Pulsed 100  $\mu s$  , 10% duty cycle



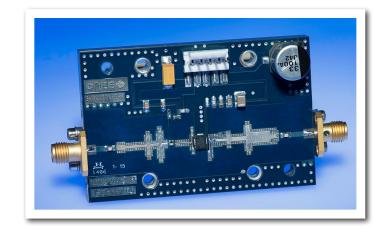
Figure 10. - Typical Pulsed Power Response  $V_{DD}$  = 40 V,  $I_{DO}$  = 60 mA, 100  $\mu$ s, 10% Duty,  $P_{IN}$  = 28 dBm



# CGHV1F006S-AMP3 Application Circuit Bill of Materials, RADAR

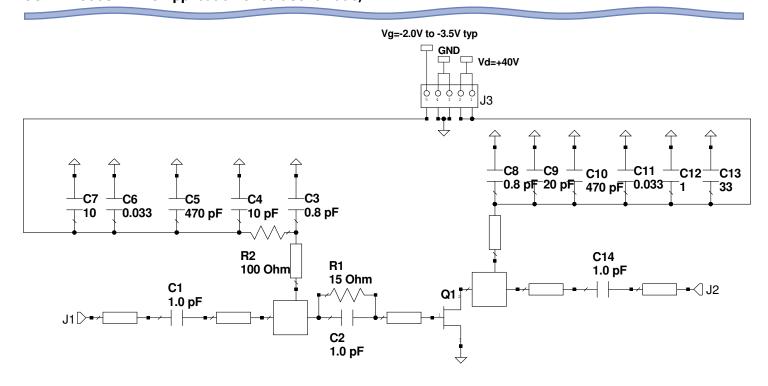
#### **CGHV1F006S-AMP3 Application Circuit**

| Designator | Description                         | Qty |
|------------|-------------------------------------|-----|
| R1         | RES, 15, OHM, +1/-1%, 1/16 W, 0402  | 1   |
| R2         | RES, 100, OHM, +1/-1%, 1/16 W, 0603 | 1   |
| C1, C14    | CAP, 1.0 pF, ±0.05 pF, 0603, ATC    | 2   |
| C2         | CAP, 1.0 pF, ±0.05 pF, 0402, ATC    | 1   |
| C3, C8     | CAP, 0.8 pF, ±0.05 pF, 0402, ATC    | 2   |
| C4         | CAP, 10 pF, ±5%, 0603, ATC          | 1   |
| C5, C10    | CAP, 470 pF, 5%, 100 V, 0603, X     | 2   |
| C6, C11    | CAP, 33000 pF, 0805, 100V, X7R      | 2   |
| C7         | CAP, 10 UF, 16 V, TANTALUM          | 1   |
| C9         | CAP, 20 pF, ±5%, 0603, ATC          | 1   |
| C12        | CAP, 1.0 UF, 100V, 10% X7R, 1210    | 1   |
| C13        | CAP, 33 UF, 20%, G CASE             | 1   |
| J1, J2     | CONN, SMA, PANEL MOUNT JACK, FLANGE | 2   |
| J3         | HEADER RT>PLZ .1CEN LK 5POS         | 1   |
| Q1         | QFN TRANSISTOR CGHV1F006S           | 1   |

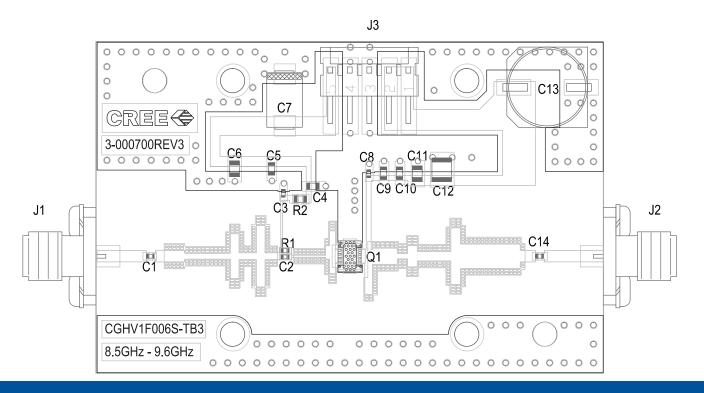




#### CGHV1F006S-AMP3 Application Circuit Schematic, RADAR



#### CGHV1F006S-AMP3 Application Circuit Outline, RADAR



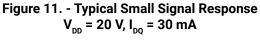


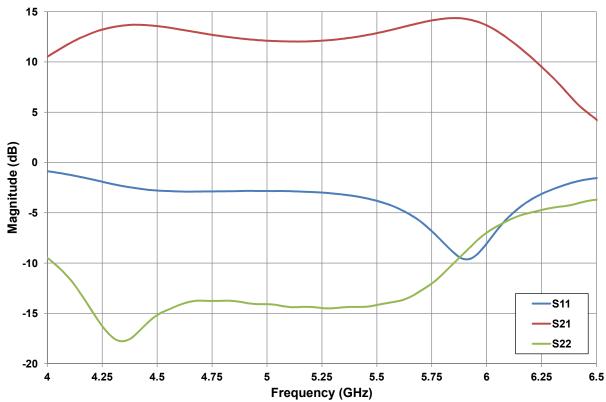
#### Electrical Characteristics When Tested in CGHV1F006S-AMP4 at 802.11

| Characteristics   | Symbol | Min. | Тур. | Max. | Units | Conditions  |  |
|---|--------|------|------|------|-------|---|--|
| RF Characteristics $^{1}$ ( $T_{c} = 25^{\circ}$ C, $F_{0} = 4.9 - 5.9$ GHz unless otherwise noted) |        |      |      |      |       |   |  |
| Gain  | G      | -    | 13   | -    | dB    | $V_{DD} = 20 \text{ V, } I_{DQ} = 30 \text{ mA, } P_{IN} = 27 \text{ dBm}$                      |  |
| Drain Efficiency <sup>2</sup>   | η      | -    | 27   | -    | %     | $V_{DD} = 20 \text{ V, } I_{DQ} = 30 \text{ mA, } P_{IN} = 27 \text{ dBm}$                      |  |
| OQPSK <sup>3</sup>  | ACLR   | -    | -43  | -    | dBc   | $V_{DD} = 20 \text{ V, } I_{DQ} = 30 \text{ mA, } P_{OUT} = 27 \text{ dBm}$                     |  |
| Output Mismatch Stress <sup>2</sup>   | VSWR   | -    | 10:1 | -    | Υ     | No damage at all phase angles, $V_{\rm DD}$ = 20 V, $I_{\rm DQ}$ = 30 mA, $P_{\rm IN}$ = 27 dBm |  |

#### Notes:

#### Typical Performance - CGHV1F006S-AMP4 at 802.11





<sup>&</sup>lt;sup>1</sup> Measured in CGHV1F006S-AMP4 Application Circuit

<sup>&</sup>lt;sup>2</sup> Single carrier WCDMA, 3GPP Test Model 1, G4 DPCH, 45% clipping, PAR = 7.5 dB @ 0.01% probability on CCDF



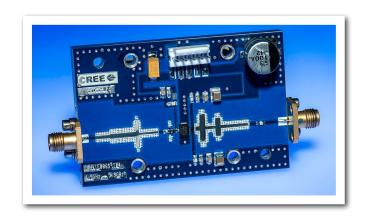
40 -37 Gain 35 -38 Drain Efficiency Drain Efficiency 30 -39 ACLR Gain (dB) & Drain Efficiency (%) 25 20 ACLR 15 -42 Gain 10 -43 5 5.0 5.9 Frequency (GHz)

Figure 12. - Typical Gain, Efficiency and WCDMA Performance vs Frequency  $V_{DD}$  = 20 V,  $I_{DO}$  = 30 mA,  $P_{OUT}$  = 27 dBm

## CGHV1F006S-AMP4 Application Circuit Bill of Materials at 802.11

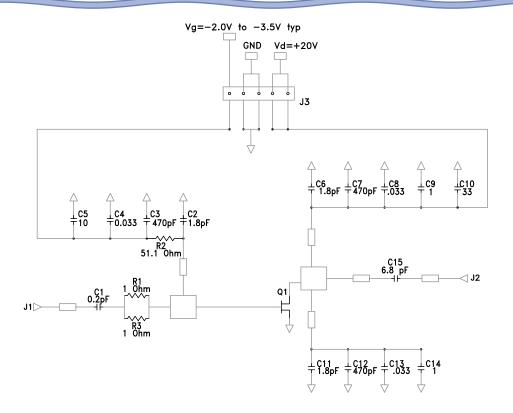
#### Designator Description Qty R1, R3 RES, 1, OHM, +/-1%, 1/16 W, 0402 2 R2 RES, 51.1, OHM, +/-1%, 1/16W, 0603 C2, C6, C11 CAP, 1.8 pF, +/-0.1 pF, 0603, ATC C1 CAP, 0.2 pF, +/-0.05 pF, 0402, ATC C3, C7, C12 CAP, 470 pF, 5%, 100 V, 0603, X 3 CAP, 33000 pF, 0805, 100 V, X7R C4, C8, C13 CAP, 10 UF, 16 V, TANTALUM C5 C15 CAP, 6.8 pF, ±0.25 pF, 100 V, 0603 C9, C14 CAP, 1.0 UF, 100V, 10% X7R, 1210 C10 CAP, 33 UF, 20%, G CASE J1, J2 CONN, SMA, PANEL MOUNT JACK, FLANGE PCB, RT5880, 0.020" THK, CGHV1F006S BASEPLATE, CGH35015, 2.60 X 1.7 J3 HEADER RT>PLZ .1CEN LK 5POS 2-56 SOC HD SCREW 1/4 SS #2 SPLIT LOCKWASHER SS Q1 QFN TRANSISTOR CGHV1F006S

#### **CGHV1F006S-AMP4 Application Circuit**

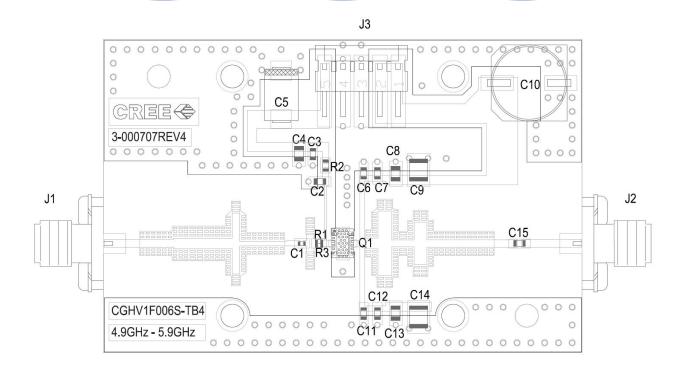




#### **CGHV1F006S-AMP4 Application Circuit Schematic**



### **CGHV1F006S-AMP4 Application Circuit Outline**





### **CGHV1F006S Power Dissipation De-rating Curve**

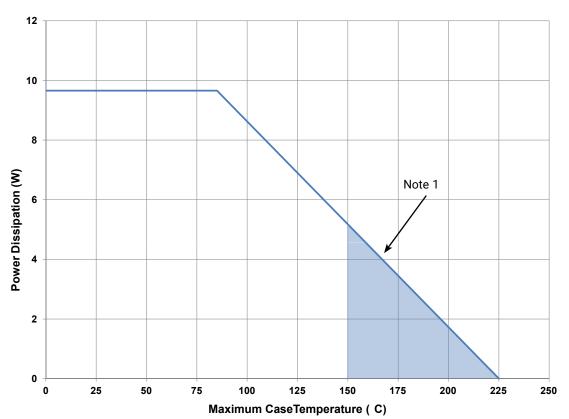


Figure 13. - CGHV1F006S Transient Power Dissipation De-Rating Curve

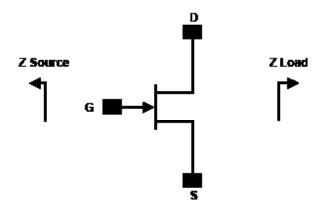
Note 1. Area exceeds Maximum Case Temperature (See Page 2).

#### **Electrostatic Discharge (ESD) Classifications**

| Parameter           | Symbol | Class              | Test Methodology    |
|---------------------|--------|--------------------|---------------------|
| Human Body Model    | НВМ    | 1A (> 250 V)       | JEDEC JESD22 A114-D |
| Charge Device Model | CDM    | 2 (125 V to 250 V) | JEDEC JESD22 C101-C |



### **Source and Load Impedances**

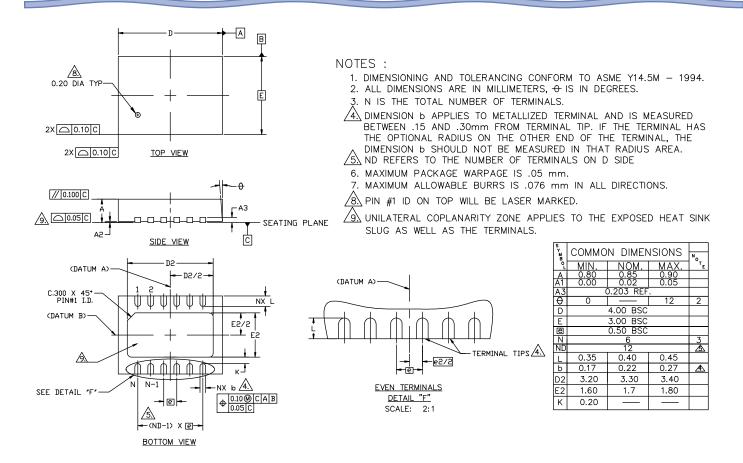


| Frequency (GHz) | Z Source        | Z Load           |
|-----------------|-----------------|------------------|
| 1               | 49.67 + j32.81  | 184.11 + j6.66   |
| 3               | 11.54 + j3.96   | 38.83 + j56.37   |
| 6               | 5.94 - j17.97   | 13.03 + j16.16   |
| 10              | 11.87 - j77.62  | 11.79 - j17.43   |
| 12              | 47.42 - j205.35 | 16.39 - j46.22   |
| 15              | 33.78 + j251.03 | 163.61 - j268.44 |

Note<sup>1</sup>:  $V_{DD}$  = 40 V,  $I_{DQ}$  = 60 mA Note<sup>2</sup>: Impedances are extracted from source and load pull data derived from the transistor.



#### Product Dimensions CGHV1F006S (Package 3 x 4 DFN)

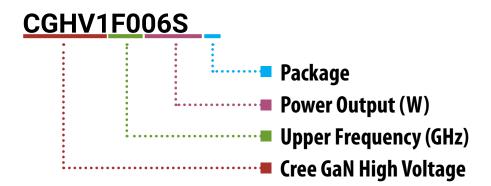


| Pin | Input/Output |         |          |     |          |   |        |        |
|-----|--------------|---------|----------|-----|----------|---|--------|--------|
| 1   | GND          |         |          |     |          |   |        | INI 10 |
| 2   | NC           | PIN 1   |          |     |          |   |        | IN 12  |
| 3   | RF IN        | _       |          |     |          |   | $\neg$ |        |
| 4   | RF IN        | L       |          | 9   |          |   |        |        |
| 5   | NC           | _       |          | 0   |          |   | _      |        |
| 6   | GND          |         | Ш        | 0   | <b>5</b> |   |        |        |
| 7   | GND          | _       | Ш        | ĬĹ. |          |   | _      |        |
| 8   | NC           | L       | <b>~</b> | =   | ×        |   |        |        |
| 9   | RF OUT       | _       | CR<br>CR |     | Ш        |   | 7      |        |
| 10  | RF OUT       | L       | U        |     |          | L |        |        |
| 11  | NC           |         |          |     |          | - | ٦ _    |        |
| 12  | GND          | PIN 6 L |          |     |          |   | J F    | PIN 7  |
|     |              |         |          |     |          |   |        |        |
|     |              |         |          |     |          |   |        |        |

Note: Leadframe finish for 3x4 DFN package is Nickel/Palladium/Gold. Gold is the outer layer.



## **Part Number System**



| Parameter                    | Value         | Units |
|------------------------------|---------------|-------|
| Upper Frequency <sup>1</sup> | 15.0          | GHz   |
| Power Output                 | 6             | W     |
| Package                      | Surface Mount | -     |

Table 1.

**Note**<sup>1</sup>: Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

| Character Code | Code Value                     |
|----------------|--------------------------------|
| А              | 0                              |
| В              | 1                              |
| С              | 2                              |
| D              | 3                              |
| E              | 4                              |
| F              | 5                              |
| G              | 6                              |
| Н              | 7                              |
| J              | 8                              |
| K              | 9                              |
| Examples:      | 1A = 10.0 GHz<br>2H = 27.0 GHz |

Table 2.



## **Product Ordering Information**

| Order Number    | Description   | Unit of Measure  | lmage  |
|-----------------|---|------------------|--|
| CGHV1F006S      | GaN HEMT  | Each             | CREES  |
| CGHV1F006S-AMP1 | Test board with GaN HEMT installed,<br>5.85 - 7.2 GHz, 50 V<br>C-Band under OQPSK | Each             | O P. L.  |
| CGHV1F006S-AMP2 | Test board with GaN HEMT installed,<br>7.9 - 8.4 GHz, 28 V<br>X-Band SATCOM       | Each             | CREE O LOUIS O |
| CGHV1F006S-AMP3 | Test board with GaN HEMT installed,<br>8.5 - 9.6 GHz, 28 V<br>X-Band RADAR        | Each             |  |
| CGHV1F006S-AMP4 | Test board with GaN HEMT installed,<br>4.9 - 5.9 GHz, 50 V<br>802.11              | Each             | CREE COLUMN COLU |
| CGHV1F006S-TR   | Delivered in Tape and Reel  | 250 parts / reel |  |



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